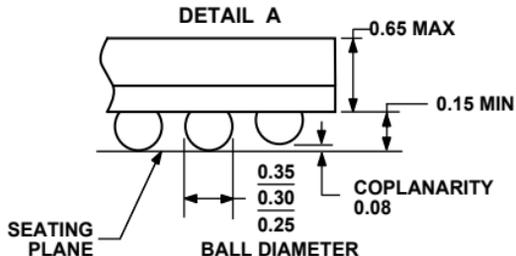
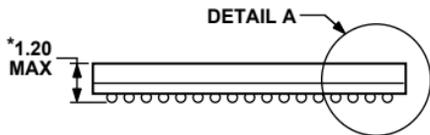
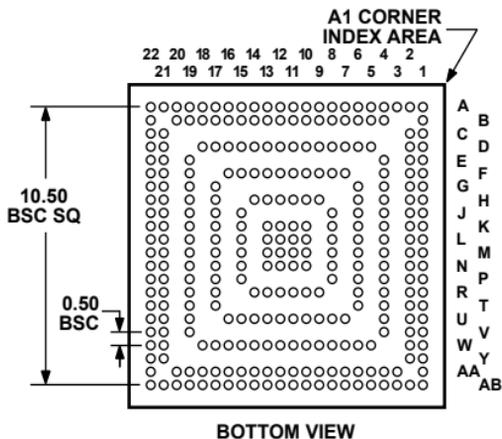
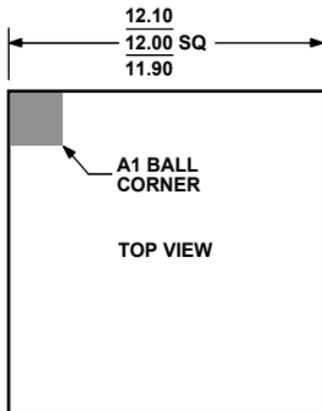


**291-Ball Chip Scale Package Ball Grid Array [CSP_BGA]
(BC-291-1)**

Dimensions shown in millimeters



*COMPLIANT TO JEDEC STANDARDS MO-195
WITH THE EXCEPTION TO PACKAGE HEIGHT.